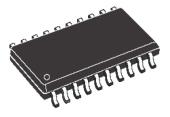




0.5 A high-side driver intelligent power switch



SO20

Features

- 0.5 A output current
- 8 to 35 V supply voltage range
- Internal current limit
- Non-dissipative short-circuit protection
- Thermal shutdown
- Undervoltage lockout with hysteresis
- Internal negative voltage clamping for fast demagnetization
- Differential inputs with large common mode range and threshold hysteresis
- Open load detection
- Two diagnostic outputs
- Open ground protection
- Output status LED driver
- Immunity against burst transient (IEC 61000-4-4)
- ESD protection (human body model ±2 kV)

Description

The L6375D is a monolithic intelligent power switch in multipower BCD technology to drive inductive, capacitive or resistive loads with controlled output voltage slew rate and short-circuit protection. An internal clamping diode enables the fast demagnetization of inductive loads. Diagnostic for CPU feedback and extensive use of electrical protections make this device robust and suitable for industrial automation applications.

Product status link							
L6375D							
Order code	Temper ature range	Package	Packing				
L6375D	-25 to		Tube				
L6375D0 13TR	+125 °C	SO20	Tape and reel				

1 Pin configuration

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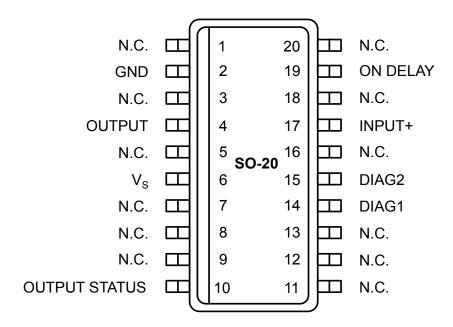


Figure 1. Pin connections (top view)

Table 1. Pin description

Pin	Pin name	Function
2	GND	Ground
4	OUTPUT	High side output with built-in current limitation
6	VS	Supply voltage input; the value of the supply voltage is monitored to detect undervoltage condition
10	Output status	This current source output is capable of driving an LED to signal the status of the output pin. The pin is active (source current) when the output pin is considered high
14	DIAG1	DIAGNOSTIC 1 output. This open drain reports the IC working conditions (see Table 6: Diagnostic truth table)
15	DIAG2	DIAGNOSTIC 2 output. This open drain reports the IC working conditions (see Table 6: Diagnostic truth table)
17	IN+	Comparator inverting input
19	ON-DELAY	Programmable ON time interval duration during short-circuit operation
1, 3, 5, 7, 8, 9, 11, 12, 13, 16, 18, 20	N.C.	Not connected

2 Maximum ratings

57

Symbol	Parameter	Value	Unit
	Supply voltage (tw ≤ 10 ms)	50	V
Vs	Supply voltage (DC)	40	V
V _S - V _{OUT}	Supply to output differential voltage	Internally limited	V
V _{od}	ON DELAY pin voltage	-0.3 to 7	V
l _{od}	ON DELAY pin current	± 1	mA
I _{out}	Output current	Internally limited	А
V _{out}	Output voltage	Internally limited	V
El	Energy inductive load: T_J = 85 °C	200	mJ
P _{tot}	Power dissipation	Internally limited	W
V _{diag}	DIAGx pin voltage	-0.3 to 40	V
I _{diag}	DIAGx pin current	-10 to 10	mA
li	IN+ pin current	20	mA
Vi	IN+ pin voltage	-10 to V _s +0.3	V
T _{op}	Ambient temperature, operating range	-25 to 85	°C
TJ	Junction temperature, operating range	-25 to 125	°C
T _{stg}	Storage temperature	-55 to 150	°C

Table 2. Absolute maximum ratings

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{th(JA)}	Thermal resistance junction-ambient	65 max. ⁽¹⁾	°C/W
R _{th(JP)}	Thermal resistance junction-pins	15 max.	0/11

1. When mounted on an FR4 printed circuit board with 0.5 cm² of Cu (at least 35 mm thick).

3 Electrical characteristics

 V_S = 24 V; T_J = -25 to 125 °C, unless otherwise specified.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Uni
V _{smin}	Supply voltage for valid diagnostic	$I_{diag} \ge 0.5 \text{ mA}; V_{diag} = 1.5 \text{ V}$	4		35	V
V _S	Operative supply voltage		8	24	35	V
V _{sth1}	Undervoltage threshold 1		7	7.5	8	V
V _{sth2}	Undervoltage threshold 2		6.5	7	7.5	V
V _{shys}	Undervoltage hysteresis		300	500	700	mV
l _q	Ouieseent ourrent	Output open		800		μA
I _{qo}	Quiescent current	Output on		1.6		mA
V _{ith}	IN+ pin threshold voltage		0.8	1.3	2	V
V _{iths}	IN+ pin threshold hysteresis		50		400	mV
V _{il}	IN+ pin low level voltage		-7		0.8	V
	NL pip bigb lovel veltage	V _S < 18 V	2		V _S -3	
V _{ih}	IN+ pin high level voltage	V _S >18 V	2		15	V
l _{ib}	IN+ pin bias current	V _i = -7 to 15 V	-250		250	μA
I _{dch}	Delay capacitor charging current	ON DELAY pin shorted-to- ground		2.5		μA
		I _{out} = 500 mA; T _J = 25 °C		200	280	mV
V	Output voltage drop	T _J = 125 °C		320	440	
V _{don}		I _{out} = 625 mA; T _J = 25 °C		250	350	
		T _J = 125 °C		400	550	
l _{olk}	Output leakage current	V_i = low; V_{out} = 0			100	μA
V _{ol}	Output low-state voltage	V _i = high; pin floating		0.8	1.5	V
V _{cl}	Internal voltage clamp (Vs- Vout)	I _o = 200 mA single pulsed = 300 ms	48	53	58	V
I _{SC}	Short-circuit output current	$V_{\rm S}$ = 8 to 35 V; R _I = 2 Ω	0.75	1.1	1.5	А
l _{old}	Open load detection current	$V_i = V_{ih}$; $T_A = 0$ to +85 °C	1	3	6	mA
V _{oth1}	Output status threshold 1 voltage		4.5	5	5.5	V
V _{oth2}	Output status threshold 2 voltage		4	4.5	5	V
V _{ohys}	Output status threshold hysteresis		300	500	700	mV
l _{osd}	Output status source current	V_{out} > V_{oth1} ; V_{OS} = 2.5 V	2		4	mA
V _{osd}	Active output status driver drop voltage	$V_{S} - V_{OS}$; I_{OS} = 2 mA; T_{A} = 0 to +85 °C		1.5	3	V
l _{osik}	Output status driver leakage current	V _{out} < V _{oth2} ; V _{OS} = 0 V; V _S = 18 to 35 V			25	μA

Table 4. Electrical characteristics

_]/

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
N/	Diama atia dara salta na	D1 / D2 = L; I _{diag} = 0.5 mA		40		
V _{dgl}	Diagnostic drop voltage	D1 / D2 = L; I _{diag} = 3 mA		250		mV
		D1 / D2 = H;				
l _{dglk}	Diagnostic leakage current	$0 < V_{dg} < V_{S}$			5	μA
		V _S = 15.6 to 35 V				
T _{max.}	Overtemperature upper threshold			150		°C
T _{hys}	Overtemperature hysteresis			20		°C
AC operation		1				
t _r - t _f	Rise or fall time	ise or fall time $V_s = 24 \text{ V}; \text{ R}_l = 70 \Omega; \text{ R}_l \text{ to}$		20		
t _d	Delay time	ground		5		– µs
dV/dt	Slew rate (rising and falling edge)		0.7	1	1.5	V/µs
t _{ON}	On-time during short-circuit condition	50 pF < C _{DON} < 2 nF		1.28		µs/pF
t _{OFF}	Off-time during short-circuit condition			64		t _{ON}
f _{max.}	Maximum operating frequency			25		kHz
Source drain N	DMOS diode	1				
V _{fsd}	Forward on voltage	I _{fsd} = 625 mA		1	1.5	V
I _{fp}	Forward peak current	t _p = 10 ms; duty cycle = 20%			2	А
t _{rr}	Reverse recovery time	I_{fsd} = 625 mA; d I_{fsd} /dt = 25 A/ µs		200		ns
t _{fr}	Forward recovery time			50		ns

3.1 Schematic diagram

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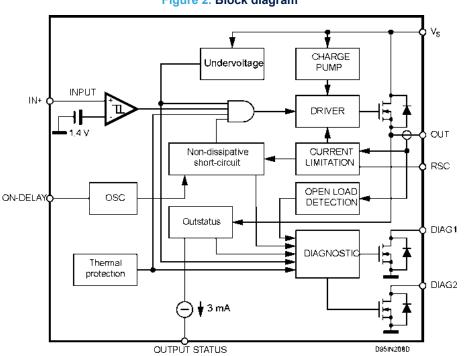
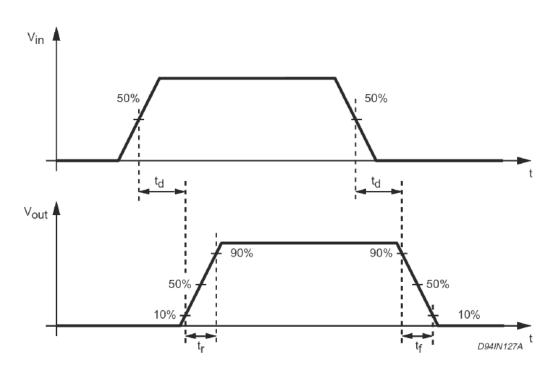


Figure 2. Block diagram





3.2 Input section

A single ended input TTL/CMOS compatible with a wide voltage range and high noise immunity (thanks to a builtin hysteresis) is available.

3.3 Overtemperature protection (OVT)

On-chip overtemperature protection provides an excellent protection of the device in extreme conditions. Whenever the temperature, measured on a central portion of the chip, exceeds $T_{max.} = 150$ °C (typical value) the device shuts down, and the DIAG2 output goes low. Normal operation is resumed as the chip temperature (normally after few seconds) falls below $T_{max.}$ - $T_{hys} = 130$ °C (typical value). The hysteresis avoids that an intermittent behavior occurs.

3.4 Undervoltage protection (UV)

The supply voltage operates correctly in a range from 8 to 35 V. Below 8 V the overall system has to be considered not reliable. To avoid any malfunctioning, the supply voltage is continuously monitored to provide an undervoltage protection. As V_s falls below V_{sth} - V_{shys} (typically 7.5 V) the output power MOSFET switches off and DIAG1 and DIAG2 output go low. Normal operation is resumed as soon as V_s exceeds V_{sth} . The hysteretic behavior prevents intermittent operation at low supply voltage.

3.5 Overcurrent operation

In order to implement a short-circuit protection, the output power MOSFET is driven to linear mode to limit the output current to the I_{SC} value (1.1 A typical value).

This condition (current limited to the I_{SC} value) lasts for a T_{ON} time interval that can be set by a capacitor (C_{DON}) connected to the ON DELAY pin according to the following formula:

Equation 1:

 t_{ON} = 1.28 µs/pF for 50 pF < C_{DON} < 2 nF

After the t_{ON} interval has expired the output power MOSFET switches off for the t_{OFF} time interval:

Equation 2:

 $t_{OFF} = 64 \cdot t_{ON}$

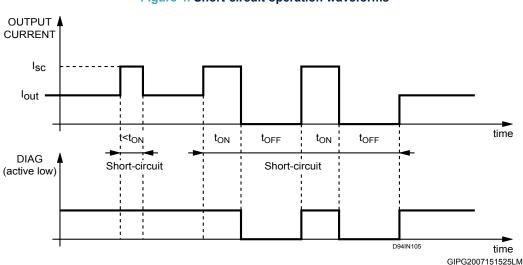


Figure 4. Short-circuit operation waveforms

When the t_{OFF} interval has expired, the output power MOSFET switches on. In this manner two conditions may occur:

- the overload is still present. In this case, the output power MOSFET is again driven to linear mode (limiting the output current to I_{SC}) for another t_{ON}, starting a new cycle
- the overload condition is removed, and the output power MOSFET is no longer driven to linear mode

This unique feature is called no-dissipative short-circuit protection and it ensures a very safe operation even in permanent overload conditions. The choice of the most appropriate value for the t_{ON} interval (the value of the

 C_{DON} capacitor) is very important, a delay (the t_{ON} itself) prevents the misleading short-circuit information is presented on the DIAG output, when capacitive loads are driven or incandescent lamp, a cold filament, has a very low resistive value. The non-dissipative short-circuit protection can be disabled (keeping t_{ON} = 0 but with the output current still limited to I_{SC}, and diagnostic disabled) by shorting to ground the ON DELAY pin.

3.6 Diagnostic logic

The operating conditions of the device are permanently monitored and the following occurrences are indicated by DIAG1/DIAG2 open drain output pins, see Section 3.8 Diagnostic truth table.

- Short-circuit vs. ground
- Short-circuit vs. VS
- Undervoltage (UV)
- Overtemperature (OVT)
- Open load, if the output current is less than 3 mA (typical value)

3.7 Demagnetization of inductive loads

An internal Zener diode, limiting the voltage across the power MOSFET between 50 and 60 V (V_{cl}), provides safe and fast demagnetization of inductive loads without the external clamping devices. The maximum energy absorbed by an inductive load is specified as 200 mJ (at T_J = 85 °C).

3.8 Diagnostic truth table

Diagnostic conditions	Input	Output	DIAG1	DIAG2
Normal operation	L	L	н	н
Normal operation	Н	Н	Н	н
Open load condition	L	L	Н	Н
(I _o < I _{old})	Н	Н	L	н
Short to V _S	L	Н	L	н
	Н	Н	L	Н
Short-circuit to ground	Н	X	Н	н
$(I_O = I_{sc})$ (ON DELAY pin grounded) ⁽¹⁾	L	L	н	Н
	L	L	Н	н
Output DMOS open	Н	L	L	н
Quartamparatura	L	L	Н	L
Overtemperature	Н	L	Н	L
Supply undervoltage	L	L	L	L
(V _S < V _{sth2})	Н	L	L	L

Table 5. Diagnostic truth table

1. A cold lamp filament or a capacitive load activates the current limiting circuit of the IPS, when the IPS is initially turned on.

4 Application circuits

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Figure 5. Input comparator hysteresis

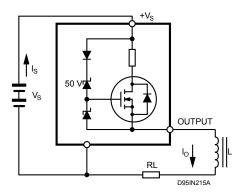
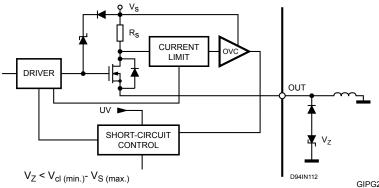
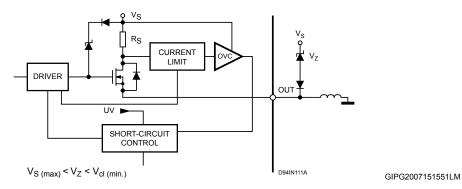


Figure 6. External demagnetization circuit (versus ground)



GIPG2007151545LM

Figure 7. External demagnetization circuit (versus VS)



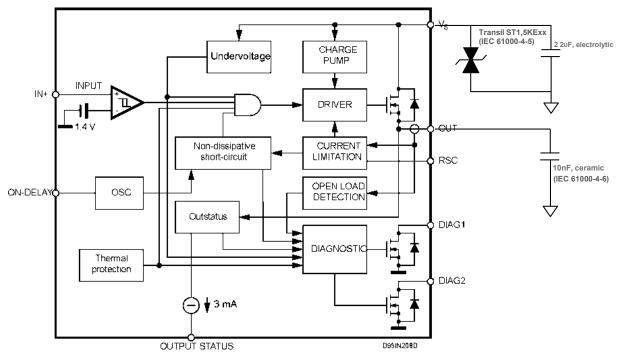


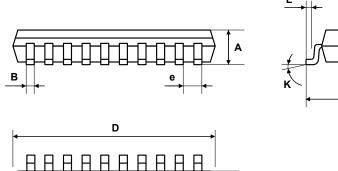
Figure 8. Application diagram

5 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

5.1 SO-20 package information

Figure 9. SO-20 package outline



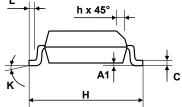
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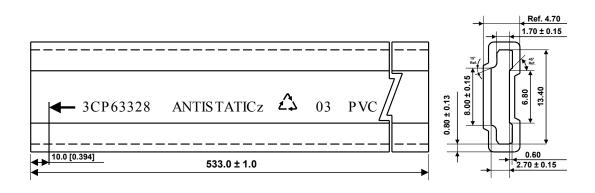
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Dim		mm			inch	
Dim.	Min.	Тур.	Max.	Min.	Тур.	Max.
А	2.35		2.65	0.093		0.104
A1	0.1		0.3	0.004		0.012
В	0.33		0.51	0.013		0.020
С	0.23		0.32	0.009		0.013
D	12.6		13	0.496		0.512
E	7.4		7.6	0.291		0.299
е		1.27			0.050	
Н	10		10.65	0.394		0.419
h	0.25		0.75	0.010		0.030
L	0.4		1.27	0.016		0.050
К	0° (min.)8° (max.)					

Table 6. SO20 mechanical data

5.2 SO20 packing information

Figure 10. Shipping tube for SOIC SO20 (measure in mm)



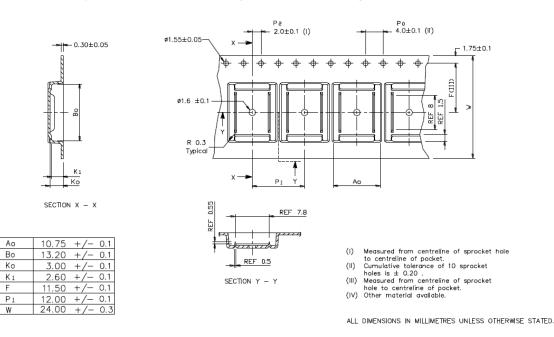
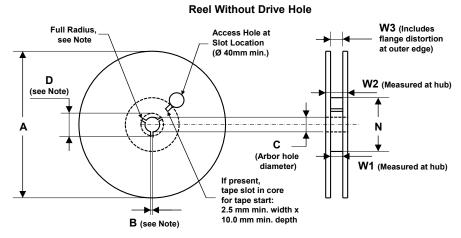


Figure 11. SOIC 20L wide body carrier tape drawing (supplier code 12)

Figure 12. SO20 reel drawing



Note: Drive spokes optional; if used, dimensions B and D shall apply.

Table 7. SO20 reel dimensions

Dim.		mm	
Dini.	Min.	Тур.	Max.
A		330	
В	1.5		
С	12.8	13.0	13.5
D	20.2		
Tape size	8		200
W		24	
Ν		7" (178)	
W1 ⁽¹⁾		24.4	24.6
W2 max		30.4	

1. Measured at the hub



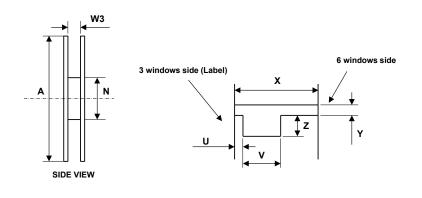


Table 8. SO20	reel side vie	ew dimensions
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Dim.	mm				
Dim.	Min.	Тур.	Max.		
Reel		7" hub (24mm)			
Х	24.5	25	25.5		
Y	0.95	1	1.05		
Z	5.5	6	6.5		
V	19	20	21		
U	1.95	2	2.05		

Revision history

Date	Revision	Changes
24-Jul-2007	1	Initial release.
29-Jun-2009	2	Updated Table 5 on page 7
21-Dec-2011	3	Updated Table 5 on page 7
15-May-2019	4	Updated Table 4. Electrical characteristics

Table 9. Document revision history



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